

**MODIFICATIONS AND RECTIFICATIONS TO SCHEDULE XXXVIII - JAPAN**  
**(Ref. G/MA/TAR/RS/12)**

NOTES TO SCHEDULE XXXVIII - JAPAN

Sub-paragraph 1(a) shall be replaced by the following :

"(a) Part I Most-Favoured-Nation Tariff

Section I Agricultural Products

Section I-A Tariffs

Section I-B Tariff Quotas

Section II Other Products

Attachment I to Section II of Part I

Attachment II to Section II of Part I"

PART I MOST-FAVOURED-NATION TARIFF

SECTION II Other Products

Notes to Section II of Part I

Delete "the Attachment to this Section" in paragraph 13 and substitute "the Attachment I to this Section".

Attachment to Section II of Part I (to become Attachment I to Section II of Part I)

Delete "Attachment" in the title and substitute "Attachment I".

Attachment II to Section II of Part I

1. Notwithstanding the provision of paragraph 3 of the Notes to the Schedule, the tariff reductions from the bound rate as of 1 January 1997 to free in respect of all products classified (or classifiable) in the tariff item numbers in List I shall be implemented in four equal rate reductions as follows :

- (a) The first reduction shall be implemented on the date that this instrument becomes effective;
- (b) The second reduction shall be implemented on 1 January 1998;
- (c) The third and fourth reductions shall be implemented on 1 January 1999.

[2. Notwithstanding the provision of paragraph 3 of the Notes to the Schedule, the tariff reductions from the bound rate as of 1 January 1997 to free in respect of all products classified (or classifiable) in the tariff item numbers in List II shall be implemented in four equal rate reductions as follows :

- (a) The first reduction shall be implemented on the date that this instrument becomes effective;
- (b) The second reduction shall be implemented on 1 January 1998;
- (c) The third reduction shall be implemented on 1 January 1999;
- (d) The fourth reduction shall be implemented on 1 January 2000.

Of the products classified (or classifiable) in the tariff item numbers marked with an asterisk ("\*"), only those of a kind used for telecommunications are covered by the tariff reduction. ]

3. Notwithstanding the provision of paragraph 3 of the Notes to the Schedule, the tariff reductions from the bound rate as of 1 January 1997 to free in respect of the products in Lists III and IV, wherever they are classified, shall be implemented in four equal rate reductions as follows :

- (a) The first reduction shall be implemented on the date that this instrument becomes effective;

- (b) The second reduction shall be implemented on 1 January 1998;
  - (c) The third and fourth reductions shall be implemented on 1 January 1999.
4. Rounding of the rates after each reduction implemented shall be subject to the provisions in paragraph 5 of the Notes to the Schedule.

List I

8421.91, 8424.89, 8424.90, 8464.20, 8464.90, 8466.91, 8466.93, 8469.11, 8470.10, 8470.21, 8470.29, 8470.30,  
8470.90, 8471.10, 8471.30, 8471.41, 8471.49, 8471.50, 8471.60, 8471.70, 8471.80, 8471.90, 8473.21, 8473.29,  
8473.30, 8473.50, 8480.71, 8504.40, 8504.50, 8518.10, 8518.29, 8518.30, 8520.20, 8523.90, 8524.31, 8524.39,  
8524.40, 8524.91, 8524.99, 8525.40, 8532.10, 8533.10, 8533.21, 8533.29, 8533.31, 8533.39, 8533.40, 8536.50,  
8541.10, 8541.21, 8541.29, 8541.30, 8541.40, 8541.50, 8541.60, 8542.12, 8542.13, 8542.14, 8542.19, 8542.30,  
8542.40, 8542.50, 8542.90, 8543.11, 8544.70, 9026.10, 9026.20, 9026.80, 9026.90, 9027.30, 9027.80, 9027.90,  
9030.90, 9031.41, 9031.49, 9031.90

List II

3818.00, 8544.41\*, 8544.49\*, 8544.51\*



### List III

Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers

Chemical vapor deposition apparatus for semiconductor production

Parts of chemical vapor deposition apparatus for semiconductor production

Apparatus for stripping or cleaning semiconductor wafers

Lasercutters for cutting contacting tracks in semiconductor production by laser beam

Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips

Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips

Parts of dicing machines for scribing or scoring semiconductor wafers

Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam

Parts of apparatus for stripping or cleaning semiconductor wafers

Encapsulation equipment for assembly of semiconductors

Parts of encapsulation equipment

Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices

Apparatus for physical deposition by sputtering on semiconductor wafers

Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays

Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors

Machines for bending, folding and straightening semiconductor leads

Physical deposition apparatus for semiconductor production

Spinners for coating photographic emulsions on semiconductor wafers

Parts of apparatus for physical deposition by sputtering on semiconductor wafers

Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors

Parts for spinners for coating photographic emulsions on semiconductor wafers

Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays

Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices

Parts of encapsulation equipment for assembly of semiconductors

Parts of machines for bending, folding and straightening semiconductor leads

Parts of physical deposition apparatus for semiconductor production

Apparatus for rapid heating of semiconductor wafers

Parts of apparatus for rapid heating of wafers

Wafer probers

Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles

Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles

Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles

Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles

Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles

Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles

Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates

Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates

Parts of such pattern generating apparatus

## List IV <sup>1</sup>

### Computers <sup>2</sup> :

Automatic data processing machines <sup>3</sup> capable of;

- (a) storing the processing program or programs and at least the data immediately necessary for the execution of the program;
- (b) being freely programmed in accordance with the requirements of the user;
- (c) performing arithmetical computations specified by the user; and
- (d) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run.

Electric amplifiers used as repeaters in line telephony products in Lists I-IV, and parts thereof.

Flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products in Lists I-IV, and parts thereof.

### Network equipments :

Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units -- including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof.

### Monitors :

Display units of automatic data processing machines <sup>4</sup> with a cathode ray tube with a dot screen pitch smaller than 0.4mm not capable of

receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing units of computers as defined above.

Optical disc storage units, for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, and whether or not in their own housings.

Paging alert devices, and parts thereof.

Plotters whether input or output units of HS heading No 8471, and whether drawing or drafting machines of HS heading No 9017.

Printed circuit assemblies, consisting of one or more printed circuits of HS heading No 8534 with one or more active elements<sup>5</sup> assembled thereon, with or without passive elements, for products in Lists I-IV, including such assemblies for external connections such as cards that conform to the PCMCIA standard.

Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit.

Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.

Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the automatic data processing machines and units thereof to process audio signals (sound cards).

Set top boxes which have a communication function :

Microprocessor-based devices incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange.

#### Notes

1. "Parts" in this List means those classified in headings specified in accordance with Note 2 (b) to Section XVI and Note 2 (b) to Chapter 90 of International Convention on the Harmonized Commodity Description and Coding System.
2. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine and not otherwise specified in Lists I-IV are not covered by these Lists.
3. Automatic data processing machines are included whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals.
4. Televisions (including high definition televisions) are not included.
5. "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of HS heading No 8541, and integrated circuits and micro assemblies of HS heading No 8542.